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## Initial Information Data Sheet

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### Applicant Information

Applicant Authority Type:: Inventor  
Applicant One Given Name:: Hui Lin  
Family Name:: Chang  
Postal Address Line One:: 50 Ta-Hsueh Road, 10F-4  
City:: Hsin-Chu  
Country:: Taiwan, R.O.C.  
Postal or Zip Code:: 300-50  
Country of Residence:: Taiwan, R.O.C.  
Citizenship Country:: Taiwan, R.O.C.

### Correspondence Information

Correspondence Customer Number:: 27683

### Application Information

Title Line One:: INSULATING LAYER HAVING DECREASED  
Title Line Two:: DIELECTRIC CONSTANT AND INCREASED  
Title Line Three:: HARDNESS  
Total Drawing Sheets:: 2  
Formal Drawings?: Yes  
Application Type:: Utility  
Docket Number:: 24061.36 (TSMC2002-0939)

### Representative Information

Registration Number:: 42,044

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### Assignee Information

Assignee Name::	Taiwan Semiconductor Manufacturing Co., Ltd.
Street of mailing address::	No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park
City::	Hsin-Chu
Country of mailing address::	Taiwan, R.O.C.
Postal or Zip Code::	300-77

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